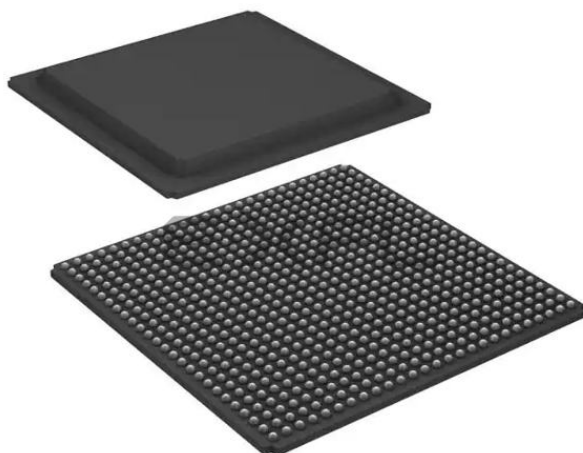




Welcome to [E-XFL.COM](https://www.e-xfl.com)

Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	2320
Number of Logic Elements/Cells	20880
Total RAM Bits	1622016
Number of I/O	404
Number of Gates	-
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	676-BGA
Supplier Device Package	676-FBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2vp20-5fg676i

Table 11: LVCMOS Programmable Currents (Sink and Source)

SelectIO-Ultra	Programmable Current (Worst-Case Guaranteed Minimum)						
LVTTL	2 mA	4 mA	6 mA	8 mA	12 mA	16 mA	24 mA
LVCMOS33	2 mA	4 mA	6 mA	8 mA	12 mA	16 mA	24 mA
LVCMOS25	2 mA	4 mA	6 mA	8 mA	12 mA	16 mA	24 mA
LVCMOS18	2 mA	4 mA	6 mA	8 mA	12 mA	16 mA	n/a
LVCMOS15	2 mA	4 mA	6 mA	8 mA	12 mA	16 mA	n/a

Figure 23 shows the SSTL2, SSTL18, and HSTL configurations. HSTL can sink current up to 48 mA. (HSTL IV)

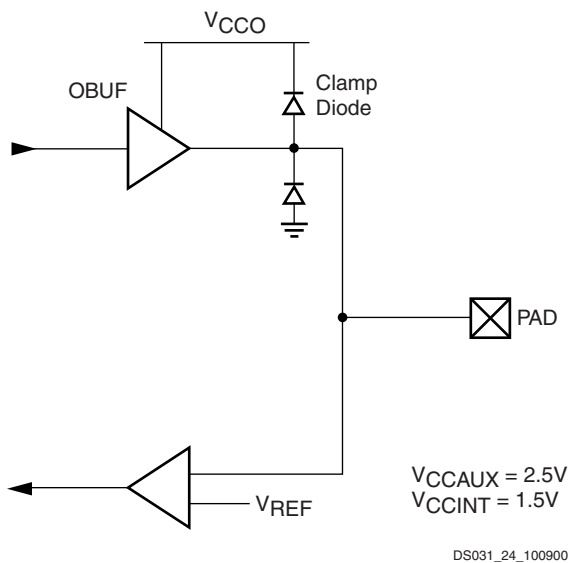


Figure 23: SSTL or HSTL SelectIO-Ultra Standards

All pads are protected against damage from electrostatic discharge (ESD) and from over-voltage transients. Virtex-II Pro uses two memory cells to control the configuration of an I/O as an input. This is to reduce the probability of an I/O configured as an input from flipping to an output when subjected to a single event upset (SEU) in space applications.

Prior to configuration, all outputs not involved in configuration are forced into their high-impedance state. The pull-down resistors and the weak-keeper circuits are inactive. The dedicated pin HSWAP_EN controls the pull-up resistors prior to configuration. By default, HSWAP_EN is set High, which disables the pull-up resistors on user I/O pins. When HSWAP_EN is set Low, the pull-up resistors are activated on user I/O pins.

All Virtex-II Pro IOBs (except RocketIO transceiver pins) support IEEE 1149.1 and IEEE 1532 compatible Boundary-Scan testing.

Input Path

The Virtex-II Pro IOB input path routes input signals directly to internal logic and / or through an optional input flip-flop or latch, or through the DDR input registers. An optional delay element at the D-input of the storage element eliminates pad-to-pad hold time. The delay is matched to the internal clock-distribution delay of the Virtex-II Pro device, and when used, assures that the pad-to-pad hold time is zero.

Each input buffer can be configured to conform to any of the low-voltage signaling standards supported. In some of these standards the input buffer utilizes a user-supplied threshold voltage, V_{REF} . The need to supply V_{REF} imposes constraints on which standards can be used in the same bank. See I/O banking description.

Output Path

The output path includes a 3-state output buffer that drives the output signal onto the pad. The output and / or the 3-state signal can be routed to the buffer directly from the internal logic or through an output / 3-state flip-flop or latch, or through the DDR output / 3-state registers.

Each output driver can be individually programmed for a wide range of low-voltage signaling standards. In most signaling standards, the output High voltage depends on an externally supplied V_{CCO} voltage. The need to supply V_{CCO} imposes constraints on which standards can be used in the same bank. See I/O banking description.

I/O Banking

Some of the I/O standards described above require V_{CCO} and V_{REF} voltages. These voltages are externally supplied and connected to device pins that serve groups of IOB blocks, called banks. Consequently, restrictions exist about which I/O standards can be combined within a given bank.

Eight I/O banks result from dividing each edge of the FPGA into two banks, as shown in Figure 24 and Figure 25. Each bank has multiple V_{CCO} pins, all of which must be connected to the same voltage. This voltage is determined by the output standards in use.

Table 4: Quiescent Supply Current

Symbol	Description	Device	Typ ⁽¹⁾	Max	Units
I _{CCINTQ}	Quiescent V _{CCINT} supply current	XC2VP2	20	300	mA
		XC2VP4	30	400	mA
		XC2VP7	35	500	mA
		XC2VP20	40	600	mA
		XC2VPX20	40	600	mA
		XC2VP30	50	800	mA
		XC2VP40	60	1050	mA
		XC2VP50	70	1250	mA
		XC2VP70	85	1700	mA
		XC2VPX70	85	1700	mA
		XC2VP100	100	2200	mA
I _{CCOQ}	Quiescent V _{CCO} supply current	XC2VP2	1.0	8.0	mA
		XC2VP4	1.0	8.0	mA
		XC2VP7	1.0	8.0	mA
		XC2VP20	1.25	10	mA
		XC2VPX20	1.25	10	mA
		XC2VP30	1.25	10	mA
		XC2VP40	1.25	10	mA
		XC2VP50	1.5	12	mA
		XC2VP70	1.5	12	mA
		XC2VPX70	1.5	12	mA
		XC2VP100	1.75	15	mA
I _{CCAUXQ}	Quiescent V _{CCAUX} supply current	XC2VP2	5	50	mA
		XC2VP4	5	50	mA
		XC2VP7	5	50	mA
		XC2VP20	10	75	mA
		XC2VPX20	10	75	mA
		XC2VP30	10	75	mA
		XC2VP40	10	75	mA
		XC2VP50	20	100	mA
		XC2VP70	20	100	mA
		XC2VPX70	20	100	mA
		XC2VP100	20	125	mA

Notes:

1. Typical values are specified at nominal voltage, 25° C.
2. Quiescent current parameter values are specified for Commercial Grade. For Industrial Grade values, multiply Commercial Grade values by 1.5.
3. With no output current loads, no active input pull-up resistors, all I/O pins are 3-state and floating.
4. If DCI or differential signaling is used, more accurate quiescent current estimates can be obtained by using the Power Estimator or XPOWER™.

Table 24: RocketIO X Receiver Switching Characteristics⁽¹⁾

Description	Symbol	Conditions	Min	Typ	Max	Units
Receive total jitter tolerance using default equalization and PRBS-15 pattern	T_{JTOL}	2.488 Gb/s		0.80	0.65	UI ⁽²⁾
		3.125 Gb/s		0.80	0.65	UI
		4.25 Gb/s		0.80	0.65	UI
		6.25 Gb/s		0.80	0.65	UI
Receive random jitter tolerance	T_{RJTO}	2.488 Gb/s		0.30		UI
		3.125 Gb/s		0.30		UI
		4.25 Gb/s		0.30		UI
		6.25 Gb/s		0.30		UI
Receive sinusoidal jitter tolerance measured at 70 MHz	T_{SJTO}	2.488 Gb/s		0.30	0.15	UI
		3.125 Gb/s		0.30	0.15	UI
		4.25 Gb/s		0.30	0.15	UI
		6.25 Gb/s		0.30	0.15	UI
Receive deterministic jitter tolerance	T_{DJTO}	2.488 Gb/s		0.55	0.45	UI
		3.125 Gb/s		0.55	0.45	UI
		4.25 Gb/s		0.55	0.45	UI
		6.25 Gb/s		0.50	0.45	UI
Receive latency ⁽³⁾	T_{RXLAT}			25	34 ⁽⁴⁾	RXUSRCLK cycles
RXUSRCLK duty cycle	T_{RXDC}		45	50	55	%
RXUSRCLK2 duty cycle	T_{RX2DC}		45	50	55	%
Differential receive input sensitivity	V_{EYE}			120	250	mV

Notes:

1. The XC2VPX70 operates at a fixed 4.25 Gb/s baud rate.
2. UI = Unit Interval
3. Receive latency delay RXP/RXN to RXDATA. Refer to [RocketIO X Transceiver User Guide](#) for more information on calculating latency.
4. This maximum may occur when certain conditions are present and clock correction and channel bonding are enabled. If these functions are both disabled, the maximum will be near the typical values.

IOB Input Switching Characteristics

Input delays associated with the pad are specified for LVCMOS 2.5V levels. For other standards, adjust the delays with the values shown in [IOB Input Switching Characteristics Standard Adjustments](#).

Table 35: IOB Input Switching Characteristics

			Speed Grade			
Description	Symbol	Device	-7	-6	-5	Units
Propagation Delays						
Pad to I output, no delay	T _{IOPI}	All	0.84	0.87	0.91	ns, max
Pad to I output, with delay	T _{IOPID}	XC2VP2	1.84	1.94	2.06	ns, max
		XC2VP4	1.84	1.94	2.06	ns, max
		XC2VP7	1.84	1.94	2.06	ns, max
		XC2VP20	2.14	2.23	2.37	ns, max
		XC2VPX20	2.14	2.23	2.37	ns, max
		XC2VP30	2.14	2.26	2.46	ns, max
		XC2VP40	2.54	2.67	2.81	ns, max
		XC2VP50	2.54	2.68	2.87	ns, max
		XC2VP70	2.54	2.72	2.91	ns, max
		XC2VPX70	2.54	2.72	2.91	ns, max
		XC2VP100	N/A	4.71	4.80	ns, max
Propagation Delays						
Pad to output IQ via transparent latch, no delay	T _{IOPLI}	All	0.86	0.89	0.93	ns, max
Pad to output IQ via transparent latch, with delay	T _{IOPLID}	XC2VP2	2.30	2.62	2.97	ns, max
		XC2VP4	2.57	2.89	3.23	ns, max
		XC2VP7	2.50	2.84	3.17	ns, max
		XC2VP20	2.65	3.04	3.42	ns, max
		XC2VPX20	2.65	3.04	3.42	ns, max
		XC2VP30	2.69	3.12	3.51	ns, max
		XC2VP40	3.30	3.63	4.03	ns, max
		XC2VP50	3.86	4.10	4.45	ns, max
		XC2VP70	4.00	4.25	4.57	ns, max
		XC2VPX70	4.00	4.25	4.57	ns, max
		XC2VP100	N/A	6.50	7.06	ns, max
Clock CLK to output IQ	T _{IOCKIQ}	All	0.60	0.60	0.67	ns, max

Clock Distribution Switching Characteristics

Table 41: Clock Distribution Switching Characteristics

Description	Symbol	Speed Grade			Units
		-7	-6	-5	
Global Clock Buffer I input to O output	T_{GIO}	0.05	0.057	0.064	ns, max
Global Clock Buffer S input Setup/Hold to I1 and I2 inputs	T_{GSI}/T_{GIS}	0.49/–0.10	0.54/–0.12	0.60/–0.13	ns, max

CLB Switching Characteristics

Delays originating at F/G inputs vary slightly according to the input used (see [Figure 34](#) in Module 2). The values listed below are worst-case. Precise values are provided by the timing analyzer.

Table 42: CLB Switching Characteristics

		Speed Grade			
Description	Symbol	-7	-6	-5	Units
Combinatorial Delays					
4-input function: F/G inputs to X/Y outputs	T _{ILO}	0.28	0.32	0.36	ns, max
5-input function: F/G inputs to F5 output	T _{IF5}	0.59	0.65	0.73	ns, max
5-input function: F/G inputs to X output	T _{IF5X}	0.63	0.70	0.79	ns, max
FXINA or FXINB inputs to Y output via MUXFX	T _{IFXY}	0.29	0.32	0.36	ns, max
FXINA input to FX output via MUXFX	T _{INAFX}	0.29	0.32	0.36	ns, max
FXINB input to FX output via MUXFX	T _{INBFX}	0.29	0.32	0.36	ns, max
SOPIN input to SOPOUT output via ORCY	T _{SOPSOP}	0.11	0.13	0.14	ns, max
Incremental delay routing through transparent latch to XQ/YQ outputs	T _{IFNCTL}	0.23	0.24	0.27	ns, max
Sequential Delays					
FF Clock CLK to XQ/YQ outputs	T _{CKO}	0.37	0.38	0.42	ns, max
Latch Clock CLK to XQ/YQ outputs	T _{CKLO}	0.54	0.57	0.64	ns, max
Setup and Hold Times Before/After Clock CLK					
BX/BY inputs	T _{DICK} /T _{CKDI}	0.21/–0.04	0.24/–0.05	0.27/–0.06	ns, min
DY inputs	T _{DYCK} /T _{CKDY}	0.00/ 0.12	0.00/ 0.14	0.00/ 0.15	ns, min
DX inputs	T _{DXCK} /T _{CKDX}	0.00/ 0.12	0.00/ 0.14	0.00/ 0.15	ns, min
CE input	T _{CECK} /T _{CKCE}	0.27/ 0.01	0.34/ 0.01	0.47/ 0.01	ns, min
SR/BY inputs (synchronous)	T _{RCK} /T _{CKR}	0.55/–0.01	0.60/–0.01	0.78/–0.01	ns, min
Clock CLK					
Minimum Pulse Width, High	T _{CH}	0.37	0.40	0.45	ns, min
Minimum Pulse Width, Low	T _{CL}	0.37	0.40	0.45	ns, min
Set/Reset					
Minimum Pulse Width, SR/BY inputs (asynchronous)	T _{RPW}	0.37	0.40	0.45	ns, min
Delay from SR/BY inputs to XQ/YQ outputs (asynchronous)	T _{RQ}	1.09	1.25	1.40	ns, max
Toggle Frequency (for export control)	F _{TOG}	1350	1200	1050	MHz

Notes:

1. A Zero “0” Hold Time listing indicates no hold time or a negative hold time. Negative values can not be guaranteed “best-case”, but if a “0” is listed, there is no positive hold time.

Master/Slave Serial Mode Parameters

Clock timing for Slave Serial configuration programming is shown in **Figure 8**, with Master Serial clock timing shown in **Figure 9**. Programming parameters for both Slave and Master modes are given in **Table 50**.

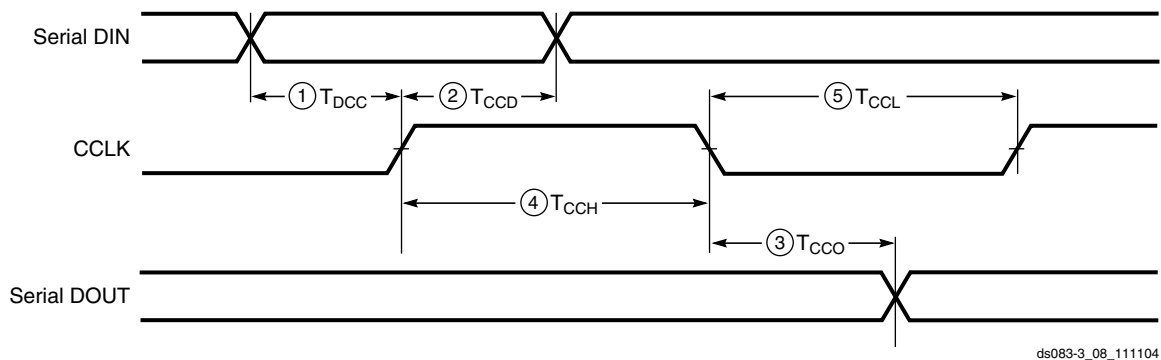


Figure 8: Slave Serial Mode Timing Sequence

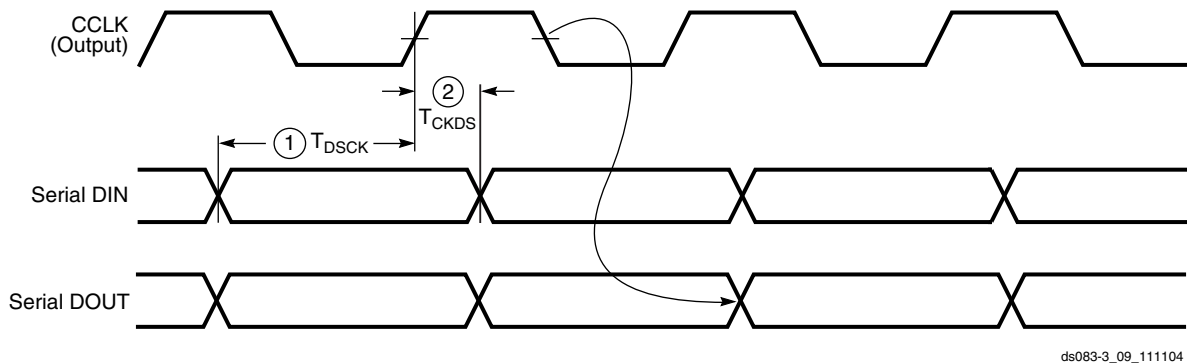


Figure 9: Master Serial Mode Timing Sequence

Table 50: Master/Slave Serial Mode Timing Characteristics

	Description	Figure References	Symbol	Value	Units
CCLK	DIN setup/hold, slave mode (Figure 8)	1/2	T_{DCC}/T_{CCD}	5.0/0.0	ns, min
	DIN setup/hold, master mode (Figure 9)	1/2	T_{DSCK}/T_{CKDS}	5.0/0.0	ns, min
	DOUT	3	T_{CCO}	12.0	ns, max
	High time	4	T_{CCH}	5.0	ns, min
	Low time	5	T_{CCL}	5.0	ns, min
	Maximum start-up frequency		$F_{CC_STARTUP}$	50	MHz, max
	Maximum frequency		F_{CC_SERIAL}	66 ⁽¹⁾	MHz, max
	Frequency tolerance, master mode with respect to nominal			+45% -30%	

Notes:

1. If no provision is made in the design to adjust the frequency of CCLK, F_{CC_SERIAL} should not exceed $F_{CC_STARTUP}$.

JTAG Test Access Port Switching Characteristics

Characterization data for some of the most commonly requested timing parameters shown in Figure 11 is listed in Table 52.

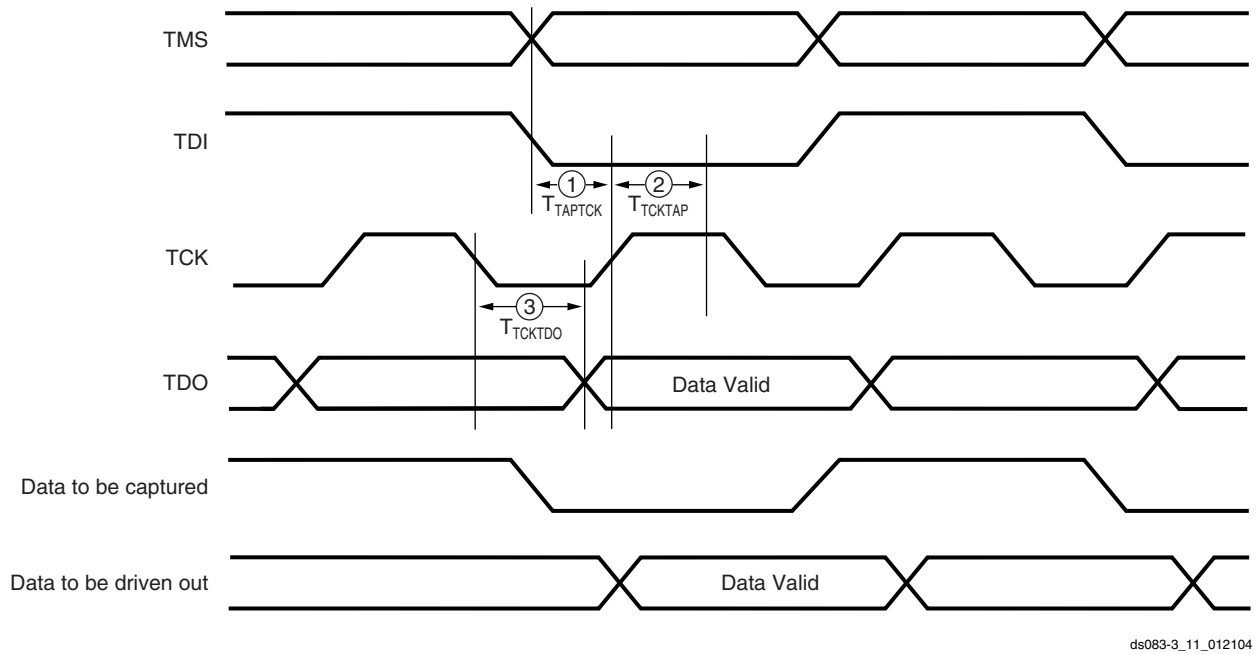


Figure 11: Virtex-II Pro Boundary Scan Port Timing Waveforms

Table 52: Boundary-Scan Port Timing Specifications

	Description	Figure References	Symbol	Value	Units
TCK	TMS and TDI setup time	1	T_{TAPTCK}	5.5	ns, min
	TMS and TDI hold times	2	T_{TCKTAP}	2.0	ns, min
	Falling edge to TDO output valid	3	T_{TCKTDO}	11.0	ns, max
	Maximum frequency		F_{TCK}	33.0	MHz, max

Table 5: FG256/FGG256 — XC2VP2 and XC2VP4

Bank	Pin Description	Pin Number
5	IO_L06N_5/VRP_5	P5
5	IO_L06P_5/VRN_5	N5
5	IO_L03N_5/D4	T3
5	IO_L03P_5/D5	T2
5	IO_L02N_5/D6	P4
5	IO_L02P_5/D7	R3
5	IO_L01N_5/RDWR_B	P3
5	IO_L01P_5/CS_B	P2
6	IO_L01P_6/VRN_6	M3
6	IO_L01N_6/VRP_6	M2
6	IO_L02P_6	N1
6	IO_L02N_6	M1
6	IO_L03P_6	M4
6	IO_L03N_6/VREF_6	L5
6	IO_L05P_6	L4
6	IO_L05N_6	L3
6	IO_L06P_6	L2
6	IO_L06N_6	L1
6	IO_L85P_6	K4
6	IO_L85N_6	K3
6	IO_L87P_6	K2
6	IO_L87N_6/VREF_6	K1
6	IO_L89P_6	K5
6	IO_L89N_6	J4
6	IO_L90P_6	J3
6	IO_L90N_6	J2
7	IO_L90P_7	J1
7	IO_L90N_7	H1
7	IO_L88P_7	H2
7	IO_L88N_7/VREF_7	H3
7	IO_L86P_7	H4
7	IO_L86N_7	G5
7	IO_L85P_7	G1

Table 6: FG456/FGG456 — XC2VP2, XC2VP4, and XC2VP7

Bank	Pin Description	Pin Number	No Connects		
			XC2VP2	XC2VP4	XC2VP7
3	IO_L49N_3	T22	NC		
3	IO_L49P_3	T21	NC		
3	IO_L48N_3	T20	NC		
3	IO_L48P_3	T19	NC		
3	IO_L47N_3	T18	NC		
3	IO_L47P_3	U18	NC		
3	IO_L45N_3/VREF_3	U22	NC		
3	IO_L45P_3	U21	NC		
3	IO_L43N_3	U20	NC		
3	IO_L43P_3	U19	NC		
3	IO_L06N_3	V22			
3	IO_L06P_3	V21			
3	IO_L05N_3	V20			
3	IO_L05P_3	V19			
3	IO_L03N_3/VREF_3	W22			
3	IO_L03P_3	W21			
3	IO_L02N_3	Y22			
3	IO_L02P_3	Y21			
3	IO_L01N_3/VRP_3	AA22			
3	IO_L01P_3/VRN_3	AB21			
4	IO_L01N_4/BUSY/DOUT ⁽¹⁾	W18			
4	IO_L01P_4/INIT_B	W17			
4	IO_L02N_4/D0/DIN ⁽¹⁾	V17			
4	IO_L02P_4/D1	V16			
4	IO_L03N_4/D2	W16			
4	IO_L03P_4/D3	Y16			
4	IO_L05_4/No_Pair	V15			
4	IO_L06N_4/VRP_4	W15			
4	IO_L06P_4/VRN_4	Y15			
4	IO_L07N_4	U14			
4	IO_L07P_4/VREF_4	V14			
4	IO_L09N_4	W14			
4	IO_L09P_4/VREF_4	W13			
4	IO_L67N_4	U13			
4	IO_L67P_4	V13			
4	IO_L69N_4	Y13			

Table 8: FF672 — XC2VP2, XC2VP4, and XC2VP7

Bank	Pin Description	Pin Number	No Connects		
			XC2VP2	XC2VP4	XC2VP7
1	IO_L06N_1	E9			
1	IO_L06P_1	E8			
1	IO_L05_1/No_Pair	F8			
1	IO_L03N_1/VREF_1	D7			
1	IO_L03P_1	E7			
1	IO_L02N_1	C6			
1	IO_L02P_1	D6			
1	IO_L01N_1/VRP_1	A3			
1	IO_L01P_1/VRN_1	B3			
2	IO_L01N_2/VRP_2	C4			
2	IO_L01P_2/VRN_2	D3			
2	IO_L02N_2	A2			
2	IO_L02P_2	B1			
2	IO_L03N_2	C2			
2	IO_L03P_2	C1			
2	IO_L04N_2/VREF_2	D2			
2	IO_L04P_2	D1			
2	IO_L05N_2	E4			
2	IO_L05P_2	E3			
2	IO_L06N_2	E2			
2	IO_L06P_2	E1			
2	IO_L40N_2/VREF_2	F5	NC	NC	NC
2	IO_L40P_2	F4	NC	NC	NC
2	IO_L42N_2	F3	NC	NC	NC
2	IO_L42P_2	F2	NC	NC	NC
2	IO_L43N_2	G6	NC		
2	IO_L43P_2	G5	NC		
2	IO_L44N_2	G4	NC		
2	IO_L44P_2	G3	NC		
2	IO_L45N_2	F1	NC		
2	IO_L45P_2	G1	NC		
2	IO_L46N_2/VREF_2	H6	NC		
2	IO_L46P_2	H5	NC		
2	IO_L47N_2	H4	NC		
2	IO_L47P_2	H3	NC		
2	IO_L48N_2	H2	NC		

Table 8: FF672 — XC2VP2, XC2VP4, and XC2VP7

Bank	Pin Description	Pin Number	No Connects		
			XC2VP2	XC2VP4	XC2VP7
7	VCCO_7	L18			
7	VCCO_7	M18			
7	VCCO_7	N18			
N/A	CCLK	W7			
N/A	PROG_B	D22			
N/A	DONE	AB6			
N/A	M0	AC22			
N/A	M1	W20			
N/A	M2	AB21			
N/A	TCK	G8			
N/A	TDI	H20			
N/A	TDO	H7			
N/A	TMS	F7			
N/A	PWRDWN_B	AC5			
N/A	HSWAP_EN	E21			
N/A	RSVD	D5			
N/A	VBATT	E6			
N/A	DXP	F20			
N/A	DXN	G19			
N/A	AVCCAUXTX7	B11			
N/A	VTTXPAD7	B12			
N/A	TXNPAD7	A12			
N/A	TXPPAD7	A11			
N/A	GND A7	C11			
N/A	RXPPAD7	A10			
N/A	RXNPAD7	A9			
N/A	VTRXPAD7	B10			
N/A	AVCCAUXRX7	B9			
N/A	AVCCAUXTX9	B6	NC	NC	
N/A	VTTXPAD9	B7	NC	NC	
N/A	TXNPAD9	A7	NC	NC	
N/A	TXPPAD9	A6	NC	NC	
N/A	GND A9	C5	NC	NC	
N/A	RXPPAD9	A5	NC	NC	
N/A	RXNPAD9	A4	NC	NC	
N/A	VTRXPAD9	B5	NC	NC	

Table 9: FF896 — XC2VP7, XC2VP20, XC2VPX20, and XC2VP30

Bank	Pin Description		Pin Number	No Connects		
	Virtex-II Pro devices	XC2VPX20 (if Different)		XC2VP7	XC2VP20, XC2VPX20	XC2VP30
2	IO_L41N_2		L8	NC		
2	IO_L41P_2		L7	NC		
2	IO_L42N_2		H4	NC		
2	IO_L42P_2		H3	NC		
2	IO_L43N_2		H2			
2	IO_L43P_2		J2			
2	IO_L44N_2		M8			
2	IO_L44P_2		M7			
2	IO_L45N_2		K6			
2	IO_L45P_2		K5			
2	IO_L46N_2/VREF_2		J1			
2	IO_L46P_2		K1			
2	IO_L47N_2		M6			
2	IO_L47P_2		M5			
2	IO_L48N_2		J4			
2	IO_L48P_2		J3			
2	IO_L49N_2		K2			
2	IO_L49P_2		L2			
2	IO_L50N_2		N8			
2	IO_L50P_2		N7			
2	IO_L51N_2		K4			
2	IO_L51P_2		K3			
2	IO_L52N_2/VREF_2		L1			
2	IO_L52P_2		M1			
2	IO_L53N_2		N6			
2	IO_L53P_2		N5			
2	IO_L54N_2		L5			
2	IO_L54P_2		L4			
2	IO_L55N_2		M2			
2	IO_L55P_2		N2			
2	IO_L56N_2		P9			
2	IO_L56P_2		R9			
2	IO_L57N_2		M4			
2	IO_L57P_2		M3			
2	IO_L58N_2/VREF_2		N1			
2	IO_L58P_2		P1			

Table 11: FF1148 — XC2VP40 and XC2VP50

Bank	Pin Description	Pin Number	No Connects	
			XC2VP40	XC2VP50
6	IO_L06N_6	AM34		
6	IO_L07P_6	AN30		
6	IO_L07N_6	AM30		
6	IO_L08P_6	AM26		
6	IO_L08N_6	AL26		
6	IO_L09P_6	AM28		
6	IO_L09N_6/VREF_6	AM29		
6	IO_L10P_6	AL33		
6	IO_L10N_6	AL34		
6	IO_L11P_6	AL27		
6	IO_L11N_6	AK27		
6	IO_L12P_6	AL29		
6	IO_L12N_6	AL30		
6	IO_L13P_6	AL32		
6	IO_L13N_6	AK32		
6	IO_L14P_6	AJ27		
6	IO_L14N_6	AJ28		
6	IO_L15P_6	AL31		
6	IO_L15N_6/VREF_6	AK31		
6	IO_L16P_6	AL28		
6	IO_L16N_6	AK28		
6	IO_L17P_6	AJ26		
6	IO_L17N_6	AH26		
6	IO_L18P_6	AJ33		
6	IO_L18N_6	AJ34		
6	IO_L19P_6	AJ31		
6	IO_L19N_6	AJ32		
6	IO_L20P_6	AG27		
6	IO_L20N_6	AG28		
6	IO_L21P_6	AK29		
6	IO_L21N_6/VREF_6	AJ29		
6	IO_L22P_6	AH33		
6	IO_L22N_6	AH34		
6	IO_L23P_6	AF27		
6	IO_L23N_6	AE27		
6	IO_L24P_6	AJ30		
6	IO_L24N_6	AH30		
6	IO_L25P_6	AH28		

Table 12: FF1517 — XC2VP50 and XC2VP70

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
2	IO_L30N_2	N6		
2	IO_L30P_2	N7		
2	IO_L31N_2	M4		
2	IO_L31P_2	N5		
2	IO_L32N_2	R11		
2	IO_L32P_2	R12		
2	IO_L33N_2	N1		
2	IO_L33P_2	N2		
2	IO_L34N_2/VREF_2	P6		
2	IO_L34P_2	P7		
2	IO_L35N_2	R13		
2	IO_L35P_2	T13		
2	IO_L36N_2	P4		
2	IO_L36P_2	P5		
2	IO_L37N_2	P3		
2	IO_L37P_2	N3		
2	IO_L38N_2	T10		
2	IO_L38P_2	T11		
2	IO_L39N_2	P1		
2	IO_L39P_2	P2		
2	IO_L40N_2/VREF_2	R7		
2	IO_L40P_2	R8		
2	IO_L41N_2	T12		
2	IO_L41P_2	U12		
2	IO_L42N_2	R5		
2	IO_L42P_2	R6		
2	IO_L43N_2	R3		
2	IO_L43P_2	R4		
2	IO_L44N_2	U8		
2	IO_L44P_2	T8		
2	IO_L45N_2	R1		
2	IO_L45P_2	R2		
2	IO_L46N_2/VREF_2	T6		
2	IO_L46P_2	T7		
2	IO_L47N_2	U9		
2	IO_L47P_2	U10		
2	IO_L48N_2	T2		
2	IO_L48P_2	T3		

Table 12: FF1517 — XC2VP50 and XC2VP70

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
N/A	GND	AU3		
N/A	GND	AT3		
N/A	GND	D3		
N/A	GND	C3		
N/A	GND	B3		
N/A	GND	AN12		
N/A	GND	G12		
N/A	GND	C12		
N/A	GND	Y10		
N/A	GND	AH9		
N/A	GND	AD9		
N/A	GND	T9		
N/A	GND	M9		
N/A	GND	AU8		
N/A	GND	AN8		
N/A	GND	G8		
N/A	GND	C8		
N/A	GND	Y6		
N/A	GND	AM5		
N/A	GND	AH5		
N/A	GND	T17		
N/A	GND	AT16		
N/A	GND	AN16		
N/A	GND	AJ16		
N/A	GND	AC16		
N/A	GND	AB16		
N/A	GND	AA16		
N/A	GND	Y16		
N/A	GND	W16		
N/A	GND	V16		
N/A	GND	U16		
N/A	GND	L16		
N/A	GND	G16		
N/A	GND	D16		
N/A	GND	AU12		
N/A	GND	AB18		
N/A	GND	AA18		
N/A	GND	Y18		

Table 13: FF1704 — XC2VP70, XC2VPX70, and XC2VP100

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
7	IO_L87P_7		AA33		
7	IO_L87N_7		AA34		
7	IO_L86P_7		Y31		
7	IO_L86N_7		Y32		
7	IO_L85P_7		Y39		
7	IO_L85N_7		Y40		
7	IO_L60P_7		Y36		
7	IO_L60N_7		Y37		
7	IO_L59P_7		Y33		
7	IO_L59N_7		Y34		
7	IO_L58P_7		W41		
7	IO_L58N_7/VREF_7		W42		
7	IO_L57P_7		W39		
7	IO_L57N_7		W40		
7	IO_L56P_7		W31		
7	IO_L56N_7		W32		
7	IO_L55P_7		W37		
7	IO_L55N_7		W38		
7	IO_L54P_7		W35		
7	IO_L54N_7		W36		
7	IO_L53P_7		W33		
7	IO_L53N_7		W34		
7	IO_L52P_7		V41		
7	IO_L52N_7/VREF_7		V42		
7	IO_L51P_7		V38		
7	IO_L51N_7		V39		
7	IO_L50P_7		V31		
7	IO_L50N_7		U32		
7	IO_L49P_7		V35		
7	IO_L49N_7		V36		
7	IO_L48P_7		V32		
7	IO_L48N_7		V33		
7	IO_L47P_7		U31		
7	IO_L47N_7		T31		
7	IO_L46P_7		U41		
7	IO_L46N_7/VREF_7		U42		

Table 13: FF1704 — XC2VP70, XC2VPX70, and XC2VP100

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
1	VCCO_1		D18		
2	VCCO_2		AA15		
2	VCCO_2		AA14		
2	VCCO_2		Y15		
2	VCCO_2		Y14		
2	VCCO_2		Y8		
2	VCCO_2		Y5		
2	VCCO_2		W15		
2	VCCO_2		W14		
2	VCCO_2		V15		
2	VCCO_2		V14		
2	VCCO_2		V3		
2	VCCO_2		U15		
2	VCCO_2		U14		
2	VCCO_2		T15		
2	VCCO_2		T14		
2	VCCO_2		R14		
2	VCCO_2		T9		
2	VCCO_2		P4		
2	VCCO_2		M6		
2	VCCO_2		J3		
2	VCCO_2		F5		
3	VCCO_3		AU5		
3	VCCO_3		AP3		
3	VCCO_3		AL6		
3	VCCO_3		AJ4		
3	VCCO_3		AH14		
3	VCCO_3		AG15		
3	VCCO_3		AG14		
3	VCCO_3		AG9		
3	VCCO_3		AF15		
3	VCCO_3		AF14		
3	VCCO_3		AE15		
3	VCCO_3		AE14		
3	VCCO_3		AE3		
3	VCCO_3		AD15		

Table 13: FF1704 — XC2VP70, XC2VPX70, and XC2VP100

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
N/A	GND		AB18		
N/A	GND		AB17		
N/A	GND		AB11		
N/A	GND		AB8		
N/A	GND		AB5		
N/A	GND		AC41		
N/A	GND		AC26		
N/A	GND		AC25		
N/A	GND		AC24		
N/A	GND		AC23		
N/A	GND		AC22		
N/A	GND		AC21		
N/A	GND		AC20		
N/A	GND		AC19		
N/A	GND		AC18		
N/A	GND		AC17		
N/A	GND		AC2		
N/A	GND		AD26		
N/A	GND		AD25		
N/A	GND		AD24		
N/A	GND		AD23		
N/A	GND		AD22		
N/A	GND		AD21		
N/A	GND		AD20		
N/A	GND		AD19		
N/A	GND		AD18		
N/A	GND		AD17		
N/A	GND		AE37		
N/A	GND		AE34		
N/A	GND		AE26		
N/A	GND		AE25		
N/A	GND		AE24		
N/A	GND		AE23		
N/A	GND		AE22		
N/A	GND		AE21		
N/A	GND		AE20		

Table 14: FF1696 — XC2VP100

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
6	IO_L52P_6	AF40	
6	IO_L52N_6	AF41	
6	IO_L53P_6	AC36	
6	IO_L53N_6	AC37	
6	IO_L54P_6	AE41	
6	IO_L54N_6	AE42	
6	IO_L55P_6	AE40	
6	IO_L55N_6	AD40	
6	IO_L56P_6	AC31	
6	IO_L56N_6	AC32	
6	IO_L57P_6	AE38	
6	IO_L57N_6/VREF_6	AE39	
6	IO_L58P_6	AD41	
6	IO_L58N_6	AD42	
6	IO_L59P_6	AB35	
6	IO_L59N_6	AB36	
6	IO_L60P_6	AD37	
6	IO_L60N_6	AD38	
6	IO_L85P_6	AC40	
6	IO_L85N_6	AC41	
6	IO_L86P_6	AB33	
6	IO_L86N_6	AB34	
6	IO_L87P_6	AC39	
6	IO_L87N_6/VREF_6	AB39	
6	IO_L88P_6	AB40	
6	IO_L88N_6	AB41	
6	IO_L89P_6	AB31	
6	IO_L89N_6	AB32	
6	IO_L90P_6	AB37	
6	IO_L90N_6	AB38	
7	IO_L90P_7	AA40	
7	IO_L90N_7	AA41	
7	IO_L89P_7	AA35	
7	IO_L89N_7	AA36	
7	IO_L88P_7	Y39	
7	IO_L88N_7/VREF_7	AA39	

Table 14: FF1696 — XC2VP100

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
7	VCCO_7	AA29	
7	VCCO_7	Y29	
7	VCCO_7	W29	
7	VCCO_7	V29	
7	VCCO_7	U29	
7	VCCO_7	T29	
7	VCCO_7	R29	
7	VCCO_7	AA28	
7	VCCO_7	Y28	
7	VCCO_7	W28	
7	VCCO_7	V28	
7	VCCO_7	U28	
7	VCCO_7	T28	
6	VCCO_6	AU39	
6	VCCO_6	AN39	
6	VCCO_6	AJ39	
6	VCCO_6	AD39	
6	VCCO_6	AW37	
6	VCCO_6	AN35	
6	VCCO_6	AJ35	
6	VCCO_6	AD35	
6	VCCO_6	AR33	
6	VCCO_6	AL33	
6	VCCO_6	AH29	
6	VCCO_6	AG29	
6	VCCO_6	AF29	
6	VCCO_6	AE29	
6	VCCO_6	AD29	
6	VCCO_6	AC29	
6	VCCO_6	AB29	
6	VCCO_6	AG28	
6	VCCO_6	AF28	
6	VCCO_6	AE28	
6	VCCO_6	AD28	
6	VCCO_6	AC28	
6	VCCO_6	AB28	
5	VCCO_5	AW33	